

Form PTO-1595 (Rev. 07/05)
OMB No. 0851-0027 (exp. 6/30/2008)

U.S. DEPARTMENT OF COMMERCE
United States Patent and Trademark Office


RECORDATION FORM COVER SHEET PATENTS ONLY

To the Director of the U.S. Patent and Trademark Office: Please record the attached documents or the new address(es) below.

1. Name of conveying party(ies): Juichi Hirasawa (02/27/2004) and Yasuo Ido (02/27/2004) Additional name(s) of conveying party(ies) attached? <input type="checkbox"/> Yes <input checked="" type="checkbox"/> No	2. Name and address of receiving party(ies) Name: <u>Mitsubishi Materials Corporation</u> Internal Address: _____ Street Address: _____ 5-1, Otemachi 1-chome Chiyoda-ku Tokyo 100-8117 JAPAN Additional name(s) & address(es) attached: <input type="checkbox"/> Yes <input checked="" type="checkbox"/> No
3. Nature of conveyance/Execution Date(s): Execution Date(s): in parentheses after inventor name <input checked="" type="checkbox"/> Assignment <input type="checkbox"/> Merger <input type="checkbox"/> Change of Name <input type="checkbox"/> Security Agreement <input type="checkbox"/> Joint Research Agreement <input type="checkbox"/> Government Interest Assignment <input type="checkbox"/> Executive Order 9424, Confirmatory License <input type="checkbox"/> Other _____	

4. Application or patent number(s): A. Patent Application No.(s) <u>10/490,972</u> Additional numbers attached? <input type="checkbox"/> Yes <input checked="" type="checkbox"/> No	<input type="checkbox"/> This document is being filed together with a new application. B. Patent No.(s) <input type="checkbox"/> Yes <input checked="" type="checkbox"/> No
---	---

5. Name and address to whom correspondence concerning document should be mailed: Name: <u>Joseph R. Robinson</u> <u>DARBY & DARBY P.C.</u> Internal Address: <u>Atty. Dkt.: 09852/0201086-US0</u> Street Address: <u>P.O. Box 5257</u> City: <u>New York</u> State: <u>NY</u> Zip: <u>10150-5257</u> Phone Number: <u>(212) 527-7783</u> Fax Number: <u>(212) 527-7701</u> Email Address: <u>jrobinson@darbylaw.com</u>	6. Total number of applications and patents involved: <u>1</u> 7. Total fee (37 CFR 1.21(h) & 3.41) \$ <u>40.00</u> <input type="checkbox"/> Authorized to be charged by credit card <input checked="" type="checkbox"/> Authorized to be charged to deposit account <input type="checkbox"/> Enclosed <input type="checkbox"/> None required (government interest not affecting title) 8. Payment Information a. Credit Card Last 4 Numbers _____ Expiration Date _____ b. Deposit Account Number <u>04-0100</u> Authorized User Name <u>Joseph R. Robinson</u>
---	---

9. Signature:  _____ Signature <u>Chris T. Mizumoto - 42,899</u> Name of Person Signing	_____ Date <u>November 23, 2005</u> Total number of pages including cover sheet, attachments, and documents: <u>3</u>
--	--

I hereby certify that this correspondence is being facsimile transmitted to the Patent and Trademark Office, facsimile no. (571) 273-0140, on the date shown below.	
Dated: _____	Signature: _____ ()

{W:\09852\0201086us\00588949.DOC (P...)}

CH \$40.00 040100 10490972

Attorney Docket No. 09852/0201086-USO**ASSIGNMENT**

I/We, the inventor(s) named below [hereinafter referred to as the Assignor(s)], have made an invention entitled:

SILVER POWDER FOR SILVER CLAY AND SILVER CLAY CONTAINING THIS SILVER POWDER

for which application for Letters Patent of the United States was executed on February 27, 2004
 herewith unless otherwise indicated below:

filed on _____, Serial No. _____, and

(Full Name, Address, and Nationality of Assignee(s))

mitsubishi materials corporation
 of 5-1, Otemachi 1-chome, Chiyoda-ku, Tokyo, Japan

[hereinafter referred to as the Assignee(s)], is/are desirous of securing the entire right, title, and interest in and to this invention, the application for United States Patent for this invention, and the Letters Patent to be issued upon this application;

Now, therefore, be it known that, for good and valuable consideration, the receipt of which from the Assignee(s) is hereby acknowledged, I/we, as Assignor(s), have sold, assigned, transferred, and set over, and do hereby sell, assign, transfer, and set over unto the Assignee(s), its/their lawful successors and assigns, my/our entire right, title, and interest in and to this invention and this application, and all divisions, and continuations thereof, and all Letters Patent of the United States which may be granted thereon, and all reissues thereof; and I/we hereby authorize and request the Commissioner of Patents and Trademarks of the United States to issue all Letters Patent for this invention in the name of the Assignee(s), its/their successors and assigns, in accordance with the terms of this assignment;

And I/we hereby further covenant and agree that I/we will, without further consideration, communicate with the Assignee(s), its/their successors and assigns, any facts known to me/us respecting this invention and testify in any legal proceeding, sign all lawful documents when called upon to do so, execute and deliver all documents that may be necessary or desirable to perfect the title to this invention in the name of the Assignee(s), its/their successors and assigns, execute all divisional, continuation, and reissue applications, make all rightful oaths and generally do everything possible to aid the Assignee(s) and its/their successors and assigns, to obtain and enforce proper patent protection for this invention in the United States, it being understood that any expense incident to the execution of such documents shall be borne by the Assignee(s), its/their successors and assigns.

Full name of (check one) Sole or First Assignor

Signature *Hirasawa* Date 27 / Feb. / 2004

Type Juichi HIRASAWA Citizenship Japan

Full name of Second Assignor, if any

Signature *I. Ido* Date 27 / Feb. / 2004

Type Yasuo IDO Citizenship Japan

Full name of Third Assignor, if any

Signature _____ Date _____

Type _____ Citizenship _____

Full name of Fourth Assignor, if any

Signature _____ Date _____

Type _____ Citizenship _____

Full name of Fifth Assignor, if any

Signature _____ Date _____

Type _____ Citizenship _____